The 30th IEEE International Conference on Micro Electro Mechanical Systems







CONFERENCE LOCATION

Rio Las Vegas Hotel and Casino 3700 West Flamingo Road • Las Vegas, NV 89103 • USA

Conference Chairs

Ellis Meng, University of Southern California, USA Clark T.-C. Nguyen, University of California, Berkeley, USA

Sponsored by







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EXHIBITING OPPORTUNITIES

EXHIBIT HOURS:

Set-Up

Sunday, January 22 13:00 - 17:00

Exhibit Hours

Monday, January 23 07:00 - 17:30

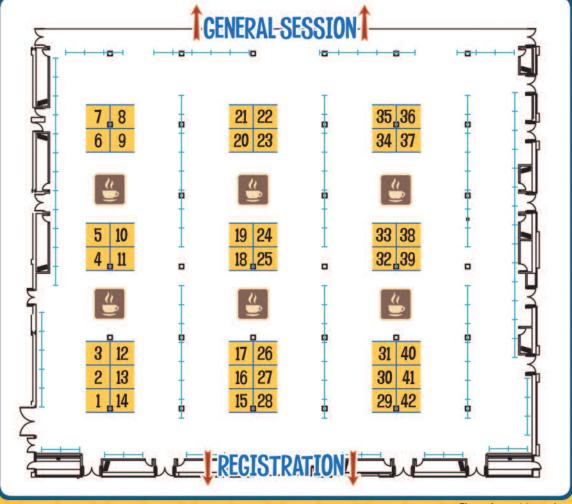
Tuesday, January 24 08:00 - 17:30

Wednesday, January 25 08:00 - 17:30

Thursday, January 26 08:00 - 13:00

Tear-Down Thursday, January 26 13:00 - 16:00

The Executive Conference Committee has the right to amend times if necessary.



Floor plan not to scale.

10' x 10' Exhibit Booth Includes:

One (1) six foot table, two (2) chairs, one (1) wastebasket, an identification sign, one (1) full conference registration, and one (1) exhibitor badge.

Table Top Exhibit Includes:

One (1) six foot table and one (1) exhibitor badge. Table tops are for government entities, academic institutions, and for start-up companies of less than four (4) years in business and who have not exhibited in a previous MEMS Conference.

All Exhibits Include:

- Company Name Listed in the Technical Digest Company Name and Contact Information in the Final Program
- Company Logo in the Opening Slide Presentation at the Conference Company Name Listed on the Welcome Sign
 - Company Name and Logo on the Conference Website with a Link to Your Website

Deadlines for Exhibits & Contributors

The signed contract and full payment must be received by December 01, 2016, to ensure the ability of the Conference Organizers to complete the benefits/terms of the contract.

A Contributor wishing to cancel their contribution prior to October 01, 2016 and after their signed application has been received will be refunded all but 50%. Cancellations after that time will not receive a refund. All cancellation notices must be made in writing.



CONTRIBUTING OPPORTUNITIES





- Benefactor of Technical Digest USB Drive Distributed to All Attendees with Company Logo
- . Benefactor of Student Awards and Wednesday Evening Banquet
- Opportunity to Address Attendees at the Wednesday Evening Banquet
- Two (2) Full Registrations
- One (1) 10'x10' Exhibit Booth (Includes One (1) Additional Full Registration)



- Benefactor of Lanyard Distributed to All Attendees with Company Logo
- Benefactor of the Wednesday Evening Banquet
- . Closing PowerPoint Slide in the General Session on Wednesday
- . Company Logo on a Tailored Sign at the Event
- One (1) Full Registration
- 50% Discount on One (1) 10'x10' Exhibit Booth (Includes One (1) Additional Full Registration)



- Benefactor of One (1) Refreshment Break w/Signage
- PowerPoint Slide in the General Session Prior to a Luncheon
- Company Logo on a Tailored Sign at the Event
- One (1) Full Registration
- 25% Discount on One (1) 10'x10' Exhibit Booth (Includes One (1) Additional Full Registration)



- Contributing Benefactor of the Sunday Welcome Reception
- Company Logo on a Tailored Sign at the Event
- One (1) Full Registration



Email exhibits@mems17.org for pricing on the following:

- Pens with Company Logo
- Totebags with Company Logo
- Notepads with Company Logo
- Lanvards
- Student Scholarships
- Media Support
- Design your own level of opportunity

Sponsorship Levels Include the Following Benefits:

• Company Name Listed in the Technical Digest • Company Name, Logo and Contact Information in the Final Program • Company Logo in the Opening Slide Presentation at the Conference • Company Logo on the Welcome Sign • Company Name and Logo on the Conference Website with a Link to Your Website



ADVERTISING OPPORTUNITIES

\$250 - 1/4 Page Ad

\$500 - 1/2 Page Ad

\$750 - 3/4 Page Ad

\$1,000 - Full Page Ad

\$500 - Your Banner in Lobby

\$500 - Advertising on the Website



CONTRACT APPLICATION

The undersigned APPLICANT, agreeing to be legally bound hereby, applies for exhibit booth space and/or benefactor level opportunity in the 30th IEEE International Conference on Micro Electro Mechanical Systems described above and is subject to the terms, conditions, and requirements stated herein. The IEEE MEMS Conference, upon its written acceptance of this Application is to assign exhibit booth space or benefactor level to the Applicant under all of the terms, conditions, and requirements as aforesaid. Applicant applies for one of the available booth locations or benefactor level at the fee indicated below. Booths and benefactor levels will be assigned on a first-come first-served basis. The Conference Committee has the right to amend booth locations if necessary.

1st Choice		2nd Choice		3rd Choice	
If none of your	requested booths are available	le at the time your application is be	ing processed, we will make every	attempt to assign space in proximity of the area requested.	
	10' x 10' Booth Space Table Top Display		Advanced On or Before October 28, 2016 \$\square\$ \$2,250.00 \$\square\$ \$1,300.00	Standard After October 28, 2016 □ \$2,500.00 □ \$1,500.00	
BENEFACTOR LEV	ELS	MEMS Benefactor G	roup	Advertising	
□ Diamond \$10,000 □ Gold \$6,000 □ Silver \$5,000 Benefactor of a Refreshment Break w/Signage □ M □ T □ W □ Bronze \$4,000		Email exhibits@mems17.org for pricing Pens with Company Logo Totebags with Company Logo Notepads with Company Logo Lanyards Student Scholarships Media Support Design Your Own Level		 \$ 250- 1/4 page Ad in Final Program \$ 500- 1/2 page Ad in Final Program \$ 750- 3/4 page Ad in Final Program \$1,000- Full Page Ad in Final Program \$ 500- Your Banner in Lobby \$ 500- Advertising on the Website 	
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		Fax:			
Website:		Com	ie: info@mems17.org		
Contact Name:					
Phone:		Email:			
Signature: Position:					
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PAYMENT IN		in USD (\$) ONLY to: <i>IEEE MEMS</i>	2017 Conference		
PAYMENT IN Check/Money Ord	der Make checks payable,	in USD (\$) ONLY to: <i>IEEE MEMS</i>		TOTAL	
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